

CRYSTAL OSCILLATOR (SPXO)

OUTPUT: CMOS





Product Number (please contact us) SG2016CAN: X1G004801xxxx00 SG-210STF: X1G004171xxxx00 SG3225CAN: X1G005961xxxx15 SG5032CAN: X1G004451xxxx00 SG7050CAN: X1G004481xxxx00

SG2016 / 3225 / 5032 / 7050CAN SG-210STF

Frequency
 Supply voltage
 Function
 Operating temperature
 20 standard frequencies
 1.8 V to 3.3 V Typ.
 Standby(\$\overline{5T}\$)
 40 °C to +105 °C











(2.0 x 1.6 mm) (2.5 x 2.0 mm) (3.2 x 2.5 mm)

SG5032CAN (5.0 x 3.2 mm)

SG7050CAN (7.0 x 5.0 mm)

Specifications (characteristics)

| Item | Symbol | Specifications | | | Conditions / Remarks | | | | |
|------------------------------|-------------------|--|--|----------------------------------|--|---|-------------------|---------------|--|
| Output frequency | fo | 14.7456 MHz 16 25 MHz 26 | MHz 10 MHz MHz 20 MHz MHz 27 MHz MHz 48 MHz | 12 MH 24 MH 32 MH 50 MH | Hz 24.576 MHz Hz 33.33 MHz | | | | |
| Supply voltage | Vcc | 1.60 V to 3.63 V 4 MHz ≤ fo ≤ 50 MHz, T_use = +105 °C M 1.71 V to 3.63 V fo = 72 MHz, T_use = +85 °C Max. 2.25 V to 3.63 V fo = 72 MHz, T_use = +105 °C Max. | | | Max. Refer to Figure 1 | | | | |
| Storage temperature | T_stg | | -55 °C to +125 -40 °C to +125 | | | SG2016CAN All others | | | |
| Operating temperature | T_use | -20 °C to +70 °C | C, -40 °C to +85 °C | C, -40 ° | 'C to +105 °C | See of figure *1 | | | |
| | | ±25 × 10 ⁻⁶ | | | -20 °C to +70 °C | | | | |
| Frequency tolerance | f_tol | | ±50 × 10 ⁻⁶ | | | -40 °C to | +85 °C, -40 °C | to +105 °C | |
| | | V _{CC} = 1.8 V ± 10 % | $V_{CC} = 2.5 \text{ V} \pm 10$ |) % V | V _{CC} = 3.3 V ± 10 % | | | | |
| | Icc | 1.5 mA Max. | 1.6 mA Max. | | 1.8 mA Max. | No load condition, 4 MHz ≤ fo ≤ 20 MHz | | | |
| Current consumption | | 1.8 mA Max. | 2.0 mA Max. | | 2.2 mA Max. | No load condition, 20 MHz < fo ≤ 40 MHz | | | |
| | | 2.1 mA Max. | 2.4 mA Max. | | 2.6 mA Max. | No load condition, 40 MHz < fo ≤ 50 MHz | | | |
| | | 2.4 mA Max. | 2.8 mA Max. | | 3.0 mA Max. | No load | condition, fo = 7 | 2 MHz | |
| Stand-by current | I_std | 2.1 µA Max. | 2.5 µA Max. | | 2.7 µA Max. | ST =GND | | | |
| Symmetry | SYM | 45 % to 55 % | | | 50 % V _C | c level, L_CMO | S ≤ 15 pF | | |
| | Voн | 90 % Vcc Min. | | | — | 1.8 V ± 10 % | 2.5 V ± 10 % | 3.3 V ± 10 % | |
| | VoL | 10 % V _{CC} Max. | | | I _{OH} | -1.5 mA 1.5 mA | -3 mA 3 mA | -4 mA 4 mA | |
| Output voltage | V _{OH-2} | V _{CC} - 0.4 V Min. | | | | 1.8 V±10 % | 2.5 V±10 % | 3.3 V±10 % | |
| | V _{OL-2} | 0.4 V Max. | | | I _{OH} | -3 mA 3 mA | -4 mA 4 mA | -6 mA 6 mA | |
| Output load condition (CMOS) | L_CMOS | 15 pF Max. | | | | 1 | | | |
| Input voltage | V _{IH} | 80 % V _{CC} Min. | | | | ST terminal | | | |
| | V _{IL} | 20 % V _{CC} Max. | | | | | | | |
| Rise time and Fall time | tr / tf | 3 ns Max. 3.5 ns Max. (@1.8 V±10 %) | | | 20 % V _{CC} to 80 % V _{CC} level, L_CMOS = 15 pF | | | | |
| Start-up time | t_str | 3 ms Max. | | | T = 0 at 90 % V _{CC} | | | | |
| Frequency aging | f_age | ±3 × 10 ⁻⁶ / year Max. | | | +25 °C, First year | | | | |

[Model: SG2016/3225/5032/7050CAN]

 Product name
 SG2016 C AN (25.000000MHz T J H A)

 (Standard form)
 ①
 ②
 ③
 ④
 ⑤
 ⑦

 ① Model
 ②Output(C: CMOS)
 ③Frequency
 ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature range

⑦Internal identification code("A" is default)

| <u></u> | |
|--------------|----------------------------|
| ④ Su | pply voltage *See Figure 1 |
| Т | 1.8 V to 3.3 V Typ. |
| K | 2.5 V to 3.3 V Typ. |

| 5)Frequency tolerance / 6)Operating temperature range | | | | |
|---|--|--|--|--|
| DB | ±25 x 10 ⁻⁶ / -20 °C to +70 °C | | | |
| JG | ±50 × 10 ⁻⁶ / -40 °C to +85 °C | | | |
| JH | ±50 × 10 ⁻⁶ / -40 °C to +105 °C | | | |

[Model: SG-210STF]

| 3St | upply voltage | *See Figure 1 |
|-----|---------------|---------------|
| Т | 1.8 V to 3.3 | |

4 Frequency 5 Frequency tolerance

| S ±25 × 10 ⁻⁶ /-20 °C to +70 °C L ±50 × 10 ⁻⁶ /-40 °C to +85 °C Y ±50 × 10 ⁻⁶ /-40 °C to +105 °C | | ⑤Frequency tolerance | | | | |
|---|---|----------------------|--|--|--|--|
| | | S | ±25 x 10 ⁻⁶ / -20 °C to +70 °C | | | |
| Y ±50 x 10 ⁻⁶ / -40 °C to +105 °C | | L | ±50 × 10 ⁻⁶ / -40 °C to +85 °C | | | |
| | Ī | Υ | ±50 × 10 ⁻⁶ / -40 °C to +105 °C | | | |

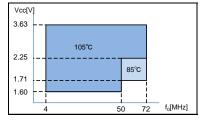
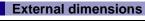
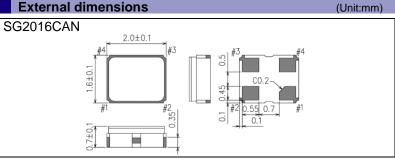


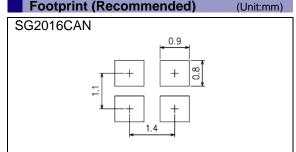
Figure 1 : The upper limit of Operating temperature and the related conditions

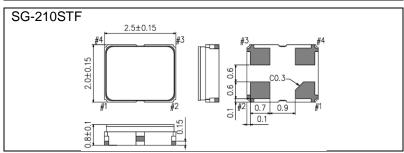
Please note that Supply voltage range (V_{CC}) depends on Output frequency (fo) and upper limit of Operationg temperature (T_use Max.).

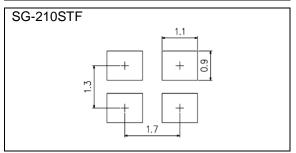


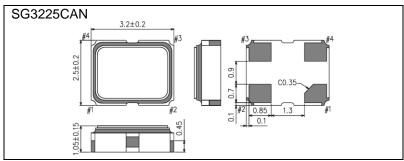
Footprint (Recommended)

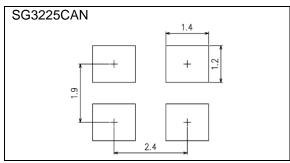


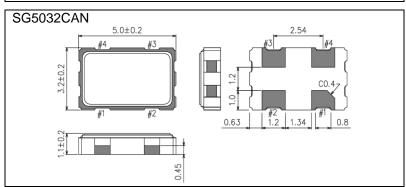


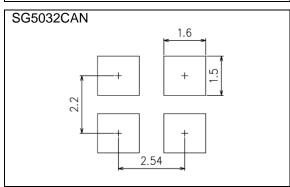


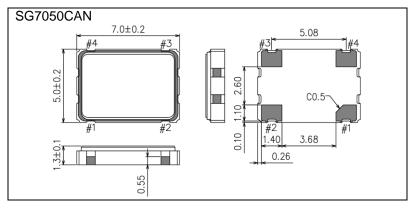


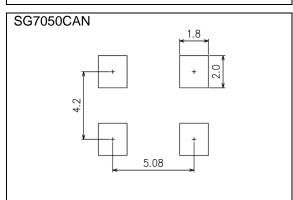












Pin Map

| Pin | Connection | Function | | | | | |
|------|-----------------|-------------|----------------|--------------------|-----------------------------|--|--|
| | | ST terminal | | | | | |
| 1 ST | СТ | | ST function | Oscillator circuit | Output | | |
| | 51 | | HIGH or "open" | Oscillation | Specified frequency: Enable | | |
| | | | LOW | Oscillation stop | High impedance: Disable | | |
| 2 | GND | Ground | | | | | |
| 3 | OUT | Clock or | utput | | | | |
| 4 | V _{cc} | Power s | supply | | | | |

■Notes: To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between Vcc - GND).

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